



**LG**

website:<http://biz.LGservice.com>  
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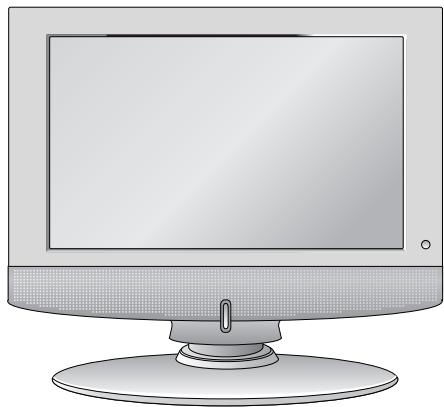
# LCD TV **SERVICE MANUAL**

**CHASSIS : CL-81**

**MODEL : 15LC1R-ZG**

## **CAUTION**

BEFORE SERVICING THE CHASSIS,  
READ THE SAFETY PRECAUTIONS IN THIS MANUAL.



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# SAFETY PRECAUTIONS

## IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by  in the Schematic Diagram and Replacement Parts List.

It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent Shock, Fire, or other Hazards.

Do not modify the original design without permission of manufacturer.

### General Guidance

An **isolation Transformer** should always be used during the servicing of a receiver whose chassis is not isolated from the AC power line. Use a transformer of adequate power rating as this protects the technician from accidents resulting in personal injury from electrical shocks.

It will also protect the receiver and its components from being damaged by accidental shorts of the circuitry that may be inadvertently introduced during the service operation.

If any fuse (or Fusible Resistor) in this TV receiver is blown, replace it with the specified.

When replacing a high wattage resistor (Oxide Metal Film Resistor, over 1W), keep the resistor 10mm away from PCB.

Keep wires away from high voltage or high temperature parts.

### Before returning the receiver to the customer,

always perform an **AC leakage current check** on the exposed metallic parts of the cabinet, such as antennas, terminals, etc., to be sure the set is safe to operate without damage of electrical shock.

### Leakage Current Cold Check(Antenna Cold Check)

With the instrument AC plug removed from AC source, connect an electrical jumper across the two AC plug prongs. Place the AC switch in the on position, connect one lead of ohm-meter to the AC plug prongs tied together and touch other ohm-meter lead in turn to each exposed metallic parts such as antenna terminals, phone jacks, etc.

If the exposed metallic part has a return path to the chassis, the measured resistance should be between  $1M\Omega$  and  $5.2M\Omega$ .

When the exposed metal has no return path to the chassis the reading must be infinite.

An other abnormality exists that must be corrected before the receiver is returned to the customer.

### Leakage Current Hot Check (See below Figure)

Plug the AC cord directly into the AC outlet.

**Do not use a line Isolation Transformer during this check.**

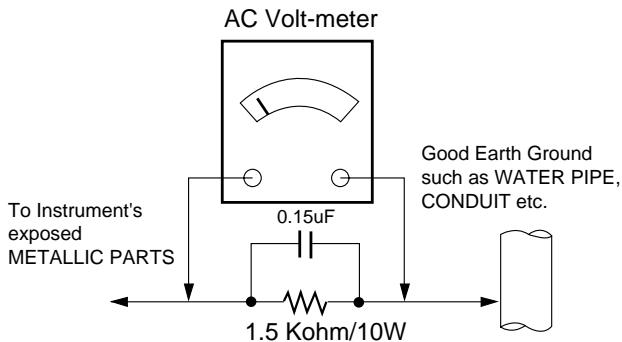
Connect 1.5K/10watt resistor in parallel with a 0.15uF capacitor between a known good earth ground (Water Pipe, Conduit, etc.) and the exposed metallic parts.

Measure the AC voltage across the resistor using AC voltmeter with 1000 ohms/volt or more sensitivity.

Reverse plug the AC cord into the AC outlet and repeat AC voltage measurements for each exposed metallic part. Any voltage measured must not exceed 0.75 volt RMS which corresponds to 0.5mA.

In case any measurement is out of the limits specified, there is possibility of shock hazard and the set must be checked and repaired before it is returned to the customer.

### Leakage Current Hot Check circuit



# SERVICING PRECAUTIONS

**CAUTION:** Before servicing receivers covered by this service manual and its supplements and addenda, read and follow the **SAFETY PRECAUTIONS** on page 3 of this publication.

**NOTE:** If unforeseen circumstances create conflict between the following servicing precautions and any of the safety precautions on page 3 of this publication, always follow the safety precautions.

Remember: Safety First.

## General Servicing Precautions

1. Always unplug the receiver AC power cord from the AC power source before;
  - a. Removing or reinstalling any component, circuit board module or any other receiver assembly.
  - b. Disconnecting or reconnecting any receiver electrical plug or other electrical connection.
  - c. Connecting a test substitute in parallel with an electrolytic capacitor in the receiver.
- CAUTION:** A wrong part substitution or incorrect polarity installation of electrolytic capacitors may result in an explosion hazard.
2. Test high voltage only by measuring it with an appropriate high voltage meter or other voltage measuring device (DVM, FETVOM, etc) equipped with a suitable high voltage probe.  
Do not test high voltage by "drawing an arc".
3. Do not spray chemicals on or near this receiver or any of its assemblies.
4. Unless specified otherwise in this service manual, clean electrical contacts only by applying the following mixture to the contacts with a pipe cleaner, cotton-tipped stick or comparable non-abrasive applicator; 10% (by volume) Acetone and 90% (by volume) isopropyl alcohol (90%-99% strength)  
**CAUTION:** This is a flammable mixture.  
Unless specified otherwise in this service manual, lubrication of contacts is not required.
5. Do not defeat any plug/socket B+ voltage interlocks with which receivers covered by this service manual might be equipped.
6. Do not apply AC power to this instrument and/or any of its electrical assemblies unless all solid-state device heat sinks are correctly installed.
7. Always connect the test receiver ground lead to the receiver chassis ground before connecting the test receiver positive lead.  
Always remove the test receiver ground lead last.
8. *Use with this receiver only the test fixtures specified in this service manual.*  
**CAUTION:** Do not connect the test fixture ground strap to any heat sink in this receiver.

## Electrostatically Sensitive (ES) Devices

Some semiconductor (solid-state) devices can be damaged easily by static electricity. Such components commonly are called **Electrostatically Sensitive (ES) Devices**. Examples of typical ES devices are integrated circuits and some field-effect transistors and semiconductor "chip" components. The following techniques should be used to help reduce the incidence of component damage caused by static by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed to

prevent potential shock reasons prior to applying power to the unit under test.

2. After removing an electrical assembly equipped with ES devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
  3. Use only a grounded-tip soldering iron to solder or unsolder ES devices.
  4. Use only an anti-static type solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ES devices.
  5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ES devices.
  6. Do not remove a replacement ES device from its protective package until immediately before you are ready to install it. (Most replacement ES devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive material).
  7. Immediately before removing the protective material from the leads of a replacement ES device, touch the protective material to the chassis or circuit assembly into which the device will be installed.
- CAUTION:** Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.
8. Minimize bodily motions when handling unpackaged replacement ES devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ES device.)

## General Soldering Guidelines

1. Use a grounded-tip, low-wattage soldering iron and appropriate tip size and shape that will maintain tip temperature within the range of 500°F to 600°F.
2. Use an appropriate gauge of RMA resin-core solder composed of 60 parts tin/40 parts lead.
3. Keep the soldering iron tip clean and well tinned.
4. Thoroughly clean the surfaces to be soldered. Use a small wire-bristle (0.5 inch, or 1.25cm) brush with a metal handle.  
Do not use freon-propelled spray-on cleaners.
5. Use the following unsoldering technique
  - a. Allow the soldering iron tip to reach normal temperature. (500°F to 600°F)
  - b. Heat the component lead until the solder melts.
  - c. Quickly draw the melted solder with an anti-static, suction-type solder removal device or with solder braid.  
**CAUTION:** Work quickly to avoid overheating the circuitboard printed foil.
6. Use the following soldering technique
  - a. Allow the soldering iron tip to reach a normal temperature (500°F to 600°F)
  - b. First, hold the soldering iron tip and solder the strand against the component lead until the solder melts.
  - c. Quickly move the soldering iron tip to the junction of the component lead and the printed circuit foil, and hold it there only until the solder flows onto and around both the component lead and the foil.  
**CAUTION:** Work quickly to avoid overheating the circuit board printed foil.
  - d. Closely inspect the solder area and remove any excess or splashed solder with a small wire-bristle brush.

### **IC Remove/Replacement**

Some chassis circuit boards have slotted holes (oblong) through which the IC leads are inserted and then bent flat against the circuit foil. When holes are the slotted type, the following technique should be used to remove and replace the IC. When working with boards using the familiar round hole, use the standard technique as outlined in paragraphs 5 and 6 above.

#### **Removal**

1. Desolder and straighten each IC lead in one operation by gently prying up on the lead with the soldering iron tip as the solder melts.
2. Draw away the melted solder with an anti-static suction-type solder removal device (or with solder braid) before removing the IC.

#### **Replacement**

1. Carefully insert the replacement IC in the circuit board.
2. Carefully bend each IC lead against the circuit foil pad and solder it.
3. Clean the soldered areas with a small wire-bristle brush. (It is not necessary to reapply acrylic coating to the areas).

### **"Small-Signal" Discrete Transistor**

#### **Removal/Replacement**

1. Remove the defective transistor by clipping its leads as close as possible to the component body.
2. Bend into a "U" shape the end of each of three leads remaining on the circuit board.
3. Bend into a "U" shape the replacement transistor leads.
4. Connect the replacement transistor leads to the corresponding leads extending from the circuit board and crimp the "U" with long nose pliers to insure metal to metal contact then solder each connection.

### **Power Output, Transistor Device**

#### **Removal/Replacement**

1. Heat and remove all solder from around the transistor leads.
2. Remove the heat sink mounting screw (if so equipped).
3. Carefully remove the transistor from the heat sink of the circuit board.
4. Insert new transistor in the circuit board.
5. Solder each transistor lead, and clip off excess lead.
6. Replace heat sink.

### **Diode Removal/Replacement**

1. Remove defective diode by clipping its leads as close as possible to diode body.
2. Bend the two remaining leads perpendicular y to the circuit board.
3. Observing diode polarity, wrap each lead of the new diode around the corresponding lead on the circuit board.
4. Securely crimp each connection and solder it.
5. Inspect (on the circuit board copper side) the solder joints of the two "original" leads. If they are not shiny, reheat them and if necessary, apply additional solder.

### **Fuse and Conventional Resistor**

#### **Removal/Replacement**

1. Clip each fuse or resistor lead at top of the circuit board hollow stake.
2. Securely crimp the leads of replacement component around notch at stake top.

3. Solder the connections.

**CAUTION:** Maintain original spacing between the replaced component and adjacent components and the circuit board to prevent excessive component temperatures.

### **Circuit Board Foil Repair**

Excessive heat applied to the copper foil of any printed circuit board will weaken the adhesive that bonds the foil to the circuit board causing the foil to separate from or "lift-off" the board. The following guidelines and procedures should be followed whenever this condition is encountered.

#### **At IC Connections**

To repair a defective copper pattern at IC connections use the following procedure to install a jumper wire on the copper pattern side of the circuit board. (Use this technique only on IC connections).

1. Carefully remove the damaged copper pattern with a sharp knife. (Remove only as much copper as absolutely necessary).
2. carefully scratch away the solder resist and acrylic coating (if used) from the end of the remaining copper pattern.
3. Bend a small "U" in one end of a small gauge jumper wire and carefully crimp it around the IC pin. Solder the IC connection.
4. Route the jumper wire along the path of the out-away copper pattern and let it overlap the previously scraped end of the good copper pattern. Solder the overlapped area and clip off any excess jumper wire.

#### **At Other Connections**

Use the following technique to repair the defective copper pattern at connections other than IC Pins. This technique involves the installation of a jumper wire on the component side of the circuit board.

1. Remove the defective copper pattern with a sharp knife. Remove at least 1/4 inch of copper, to ensure that a hazardous condition will not exist if the jumper wire opens.
2. Trace along the copper pattern from both sides of the pattern break and locate the nearest component that is directly connected to the affected copper pattern.
3. Connect insulated 20-gauge jumper wire from the lead of the nearest component on one side of the pattern break to the lead of the nearest component on the other side. Carefully crimp and solder the connections.

**CAUTION:** Be sure the insulated jumper wire is dressed so the it does not touch components or sharp edges.

## DISASSEMBLY



#1



#2 Detached stand assy (Remove the screws)



#3 Disassembly stand assy



#4 Detached Backcover (Remove the screw)



#5 Open the Backcover's latch with jig



#6 Unlock latch between Cabinet and Backcover

# SPECIFICATION

NOTE : Specifications and others are subject to change without notice for improvement.

## 1. Application range

This specification is applied to CL-81 chassis.

## 2. Requirement for Test

Testing for standard of each part must be followed in below condition.

- (1) Temperature:  $25^{\circ}\text{C} \pm 2^{\circ}\text{C}$
- (2) Humidity:  $65\% \pm 10\%$
- (3) Power: Standard input voltage (AC 100-240V, 50/60Hz)
- (4) Measurement must be performed after heat-run more than 30min.
- (5) Adjusting standard for this chassis is followed a special standard.

## 3. General Specification

No.	Item		Specification			Remark	
1	Type		TFT Color LCD Module			LPL	
	ActiveDisplay Area		15.0 inches(380.16mm) diagonal(Aspect 4:3)				
	Pixel Pitch [mm]		0.297mm(H)x0.297mm(V)xRGB				
	Electrical Interface		LVDS				
	Color Depth		6BIT, 16,777,216 colors				
	Size [mm]		332.8(H) x 262.2(V) x 18(D)				
	Surface Treatment		Anti-Glare(HAZE 3%), Hard Coating(3H)				
	Operating Mode		Normally Black				
	Back light Unit		4 CCFL(4 lamps)				
	R/T	Typ.	R.T.:5ms + F.T.:11ms(Typ)				

## 4. Mechanical Specification

No.	Item		Content			Remark
1	Product Dimension		Width(W)	Lengh(D)	Height(H)	
		Before Packing	377.6	242.8	394.5	
		After Packing	433	143	442	
2	Product Weight	Only SET	5.6Kg			
		With BOX	7.7Kg			

## 5. Reference table-Function

No.	Item	Specification	Remark
1	Teletext	TOP, FLOF	TOP(option)
2	REMOCON	NEC Code	PAL
3	AV Input	1	Rear
4	S-Video Input	1	Rear
5	Component Input	1	Rear(Option, Non EU)
6	PERI TV Connector	Full SCART : 1	Rear(Option EU)
7	RGB Input	1	D-Sub 15 pin
8	H/P Input	1	Rear
9	PC Audio Input	1	
10	RS-232	YES	Only Commercial Model
11	Discrete IR	YES	Only Commercial Model
12	2 Carrier Stereo	BG, DK	
13	NICAM Stereo	BG, I, LL'	
14	2 Carrier Daul	BG, DK	
15	NICAM Daul	BG, I, LL'	
16	DW(Double Window) Mode	X	
17	MW(Multi Window) Mode	X	
18	Film Mode	X	
19	Noise Reduction	X	
20	Progressive Scan	O	
21	Motion Detection	X	
22	SRS WOW	X	
23	Swivel Speaker	X	
24	EZ-pip	X	
25	ARC	X	
26	DRP	X	
27	DDCI	X	
28	HDCP	X	

## 6.Optical Character

No.	Item	Specification				Remark
			Min	Typ	Max	
1	Viewing Angle <CR≥10>	R/L, U/D	55/55 40/50	65/65 45/55		
2	Luminance	Luminance(cd/m <sup>2</sup> )	300	350		
		Variation			1.3	
3	Contrast Ratio	CR	300	350		All White/All Black
4	CIE Color Coordinates	WHITE (Normal)	Wx Wy	0.253 0.268	0.283 0.298	0.313 0.328
		WHITE (Warm)	Wx Wy	0.283 0.299	0.313 0.329	0.343 0.359
		WHITE (Normal)	Wx Wy	0.253 0.268	0.283 0.298	0.313 0.328
		WHITE (Cool)	Wx Wy	0.244 0.256	0.274 0.286	0.304 0.316
						In PC input Contrast 100/Brightness 50
						In AV Input PSM : Dynamic White (100 IRE)

## 7. Outgoing Condition

No	Item		Condition	Remark
1	Power		Off	
2	Volume Level		30	
3	Main Picture Input		TV	
4	Main Last Channel		Pr 01	
5	Mute		Off	
6	Station	Auto Program		
		Manual Program		
		Program Edit		
		Favorite Program		None
7	Picture	PSM		Dynamic
		CSM		Normal
		Dynamic	Contrast	100
			Brightness	50
			Colour	70
			Sharpness	50
			Tint	0
				NTSC OPTION
8	Sound	SSM		Flat
		AVL		Off
		Balance		0
9	Special	Input		TV
		Child Lock		Off
		Power Indicator		On
		Language		English(Area Management)
10	Time	Clock		-- : --
		Off Time		-- : -- Off
		On Time		-- : -- Pr. 1 Vol. 30 Off
		Auto Sleep		Off

## 8.Engineering Specification

### 8-1.General Specification

No.	Item	Specification			Remark		
1	Power Supply	H/V Sync	Video	Power Consumption	LED Color		
	Normal	On/On	Active	$\leq 40W$	BLUE		
	Stand By	Off/On	Off	$\leq 2W$	AMBER		
		On/Off					
		Off/Off					
	Cut-off Switch off	-	-	0W	OFF		
	ITEM	Specification					
2	D-SUB Pin Configuration	1: RED 3: Blue 5: S.T(GND) 7: Green GND 9: N.C 11: ID0(GND) 13: H-Sync 15: SCL	2: Green 4: ID2(GND) 6: RED GND 8: Blue GND 10: D-GND 12: SDA 14: V-Sync Shell: GND	10 : Digital GND			
3	Control Function	1) Contrast/Brightness 2) H-Position/V-Position 3) Tracking : Clock/Phase 4) Auto Configure 5)RESET					
4	Component Jack	1 : Y 3 : Pb 5 : Pr					
			PAL Multi Only				

## 9. SVC MENU OPTION

No	Item	Condition	Remark
Option1			
1	ACMS	Yes	Yes : ZG NO : TG
2	TEXT	Refer remark	TOP: below nation GERMANY BENELUX SWITZERLAND FINLAND AUSTRIA POLAND SWEDEN ITALY NORWAY SPAIN FLOP: Except above nation
3	CH+AU	Refer remark	YES : China, Australia NO : Except above area
4	AGC-L	NO	
Option2			
1	A2 ST	NO	
2	I II SAVE	refer remark	YES : TG NO : ZG
3	V-Curve	NO	
Option3			
1	Default Lang	0	According to Suffix
2	Lang Group	1	1: ZG 00 :english 08 :dansk 01 :deutsch 09 :suomi 02 :francais 10 :portugues 03 :italiano 11 :romaneste 04 :espanol 12 :polski 05 :nederlands 13 :magyar 06 :svenska 14 :chesky 07 :norsk 15 :pyccknn 2: TG 00 :english 01 :deutsch 02 :francais 03 :italiano 04 :espanol 05 :pyccknn 06 :chinese
3	TXT Lang	0 (According to Nation)	0:WEST EU:English,Deutsch,Svenska,Italiano,Francais,Espanol,Turkey 1:EAST EU:Polski,Deutsch,Estonia,Slovenia,Chesky,Romaneste 2:CYRILLIC1:Polski,Deutsch,Estonia,Letsi,pyccknn,Slovenia 3:CYRILLIC2:Polski,Deutsch,Svenska,Magyar,pyccknn,Chesky,Slovenia,Estonia 4:ARABIC:English,Francais,Turkey,Arabic
Option4			
1	2 hour Off Opt	YES	
2	Navigation Key	No	
3	Favorite key	No	

# ADJUSTMENT INSTRUCTION

## 1. Application

This document is applied to 15" LCD TV which is manufactured in Monitor (or TV) Factory or is produced on the basis of this data.

## 2. Designation

- 2.1 The adjustment is according to the order which is designated and which must be followed, according to the plan which can be changed only on agreeing.
- 2.2. Power Adjustment: Free Voltage
- 2.3. Magnetic Field Condition: Nil.
- 2.4. Input signal Unit: Product Specification Standard
- 2.5. Reserve after operation: Above 30 Minutes
- 2.6. Adjustment equipments: Pattern Generator (MSPG-925L or Equivalent), DDC Adjustment Jig equipment, SVC remote controller

## 3. Main PCB check process

### \* Caution \*

If DDC CMD don't work, please check below.

1. Enter SVC menu by SVC Remote controller (push IN-START key)
2. Enter "ETC" menu  
Check please, IIC\_SW is "0" or "1".
  - **IIC\_SW "0"**: DDC Communications.(DDC2AB) in Factory Side
  - **IIC\_SW "1"**: EDID Write/Read (DDC2B) and Factory default(Shipping Condition).

### 3.1 APC

After Manual-Insult, executing APC

### 3.2 ISP UOC file

#### 3.2.1 Required Equipment

- JIG for ISP
- PC that is installed with "WISP" program.
- Control + Power LED PCB Ass'y

#### 3.2.2 ISP Sequence

- 1) Connect main pcb ass'y with JIG for ISP
- 2) Execute "WISP" Program.
- 3) Compare UOC version in BOM with version of hex file.
- 4) Push "Browse..." button in WISP program and select hex file.
- 5) Push "Auto Execute" button
- 6) Occur an Error, try again and again. 2)~5)
- 7) After finishing ISP, Must AC Off / ON
- 8) Amber LED is blink during write default value in EEPROM(24C32)
- 9) ALL ISP process is finished when Amber LED is off and Blue LED is ON EEPROM(24C32) write.

### 3.3 ADC Process

"IIC\_SW" must set "0" for Auto Adjust (After ISP, automatically set "0")

#### 3.3.1 PC input ADC

##### 3.3.1.1 Auto Gain/Offset Adjustment

- Convert to PC in Input-source
- Signal equipment displays  
Output Voltage : 700 mVp-p  
Impress Resolution XGA (1024 x 768 @ 60Hz)  
Pattern : gray pattern that left & right is black and center is white signal (Refer below picture).  
(Model : 37, Pattern : 29 at MSPG925L)
- Adjust by commanding AUTO\_COLOR\_ADJUST(0xF1)  
0x00 0x00 instruction.

##### 3.3.1.2 Confirmation

- We confirm whether "0x00" address of EEPROM "0xA0" is "0xAA" or not.
- If "0x00" address of EEPROM "0xA0" isn't "0xAA", we adjust once more
- We can confirm the ADC values from "0x06~0x0B" addresses in a page "0xA0"

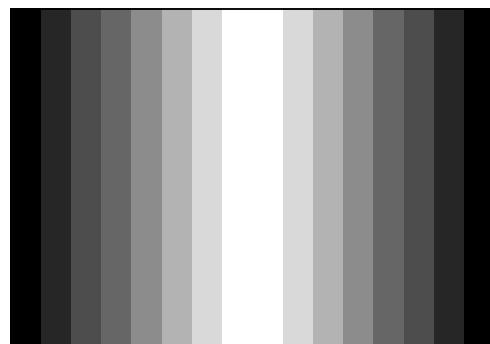
#### 3.3.2 AV input ADC

##### 3.3.2.1 Auto Gain/Offset Adjustment

- Convert to AV in Input-source
- Signal equipment displays  
Output Voltage : 700 mVp-p  
Impress Resolution : CVBS 50Hz .  
Pattern : gray pattern that left & right is black and center is white signal (Refer below picture).  
(Model: 202, Pattern: 29 at MSPG925L)
- Adjust by commanding AUTO\_COLOR\_ADJUST(0xF1)  
0x00 0x00 instruction.

##### 3.3.2.2 Confirmation

- We confirm whether "0x01" address of EEPROM "0xA0" is "0xAA" or not.
- If "0x01" address of EEPROM "0xA0" isn't "0xAA", we adjust once more
- We can confirm the ADC values from "0x0C~0x11" addresses in a page "0xA0"



<Adjustment pattern (PC and CVBS)>

### 3.4 Function Check

#### 3.4.1 DDC2B test

- "IIC\_SW" must set "1" (After ADC, automatically set "1")
- Execute DDC2B Scan Test

#### 3.4.2 Check display and sound

- "IIC\_SW" must set "1"
- Check Input and Signal items.
- 1) TV
- 2) AV1 (SCART)
- 3) AV2 (CVBS/ S-Video)
- 4) RGB-DTV
- 5) RGB-PC
- 6) PC Audio IN and H/P Out

#### 3.4.3 DCXO setting

#### 3.4.4 II\_SW setting for Total Assembly line process

- After finished all function check, "IIC\_SW" must set "0" by pushing "TILT" key in SVC remote controller

## 4. Total Assembly line process

### \* Caution \*

- If DDC CMD don't work, please check below.
1. Enter SVC menu by SVC Remote controller
  2. Enter "ETC" menu
- Check please, IIC\_SW is "0" or "1"
- **IIC\_SW "0"** : DDC Communications.(DDC2AB)
  - **IIC\_SW "1"** : EDID Write/Read (DDC2B) and Factory default.
- \* We can change IIC\_SW by pushing "TILT" key in SVC remote controller

### 4.1 Adjustment Preparation

- "IIC\_SW" must set "0"
- Above 30 minutes H/run in RF no signal
- 15 Pin D-Sub Jack is connected to the signal of Pattern Generator.

### 4.2 Confirmation of Luminance

- Set Statement
- Input : RGB PC
- Contrast : 100(Max)
- Brightness : 50
- CSM : Normal
- Signal equipment displays
- Output Voltage : 700 mVp-p
- Output Mode : Full White pattern and XGA@ 60 Hz
- Confirm whether luminance is over 200cd or not

### 4.3 Confirmation of Color Coordinate

- Input Full White Pattern (RGB PC)
- Set CSM : Normal (9300K)
- Confirm whether  $x=0.283\pm 0.03$ ,  $y=0.298\pm 0.03$  or not
- Input Full White Pattern (AV2-CVBS)
- Set CSM : Normal (9300K)
- Confirm whether  $x=0.283\pm 0.030$ ,  $y=0.298\pm 0.03$  or not

After Confirming color coordinate and luminance, "IIC\_SW" must set "1"

### 4.4 Other quality

- Confirm that each items satisfy under standard condition that was written product spec.
- Confirm Video and Sound at each source
- 1) AV
  - Select input AV1 and whether picture is displayed or not
  - Select input AV2 and whether picture is displayed or not
  - Select input S-video and whether picture is displayed or not
- 2) TV
  - Select input TV and check below item
- 1) In Gumi Factory
- C05 (E05) - ELETEXT Function Check
  - ; (Applicable to the model that has Teletext code set-up item in Product spec)
- C07 (E07) - Nicam DUAL Check
- C52 (E52) - Nicam Stereo Check

### Preset CH information

- 3) RGB-DTV
  - Select input RGB DTV and whether picture is displayed or not

### 4.5 DPM operation confirmation

Check if Power LED Color and Power Consumption operate as standard.

- Measurement Condition : 230V@ 50Hz (Analog)
- Confirm DPM operation at the state of screen without Video Signal.

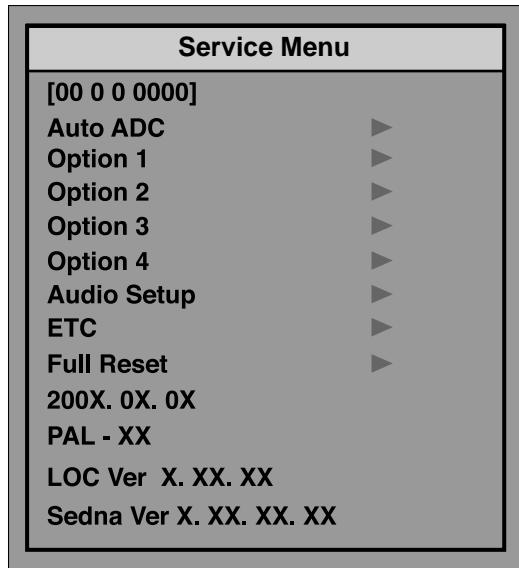
### 4.6 DDC EDID Write

- Connect D-sub Signal Cable to D-Sub Connector.
- Write EDID DATA to EEPROM(24C02) by using DDC2B protocol.
- Check whether written EDID data is correct or not. (refer to Product spec).

### 4.7 Outgoing condition Configuration

- After all test is finished, Outgoing Option setting in Service OSD. And Make Ship Condition.
- Press IN-START Key by using the SVC Remote Controller
- Press 8 digit code by SVC Remote controller refer 3854TAA001A in BOM
- After option configuration is complete, Press IN-STOP Key
- Amber LED is blink. And then Automatically turn off. . (Must not AC OFF during blink)

# SERVICE OSD



## ■ Description of operation

- [00 0 0 0000] : Country Option Code
- Option 1 ~ 4 : Detail Country Option 1~4(Refer Adjust spec sheet)
- Auto ADC : Adjust ADC in PC or AV by SVC Remote Control
- Audio Setup : Only Engineering. Don't setting
- ETC : ETC Setting

II\_SW(0 : Auto adjustment & DDC Communication in factory side/  
1 : EDID Read and Write and shipping condition)  
Write Protect (0 : EDID write / 1 : EDID write protection)

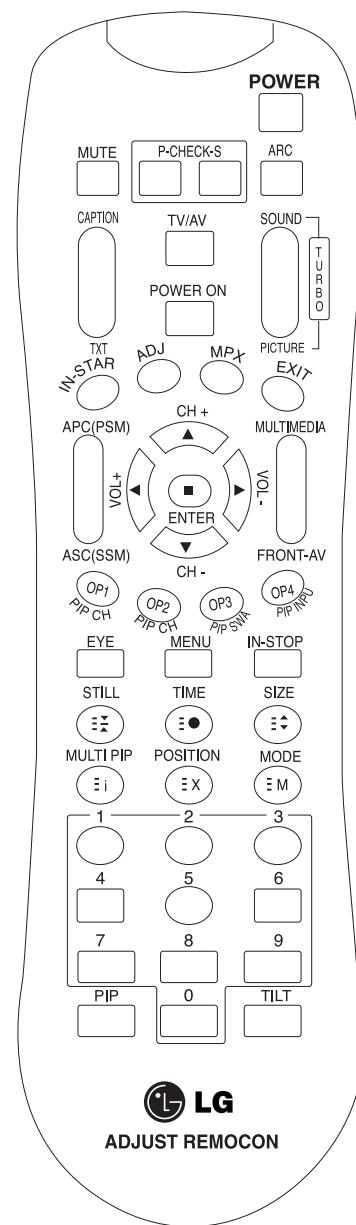
- Full Reset : Factory Reset
- 200X. 0X. 0X : Firmware update date
- PAL-XX :  inch
- LOC Ver : Video & Audio Decoder Firmware Version
- Sedna Ver : Scaler Firmware Version

## ■ How to enter SVC Menu

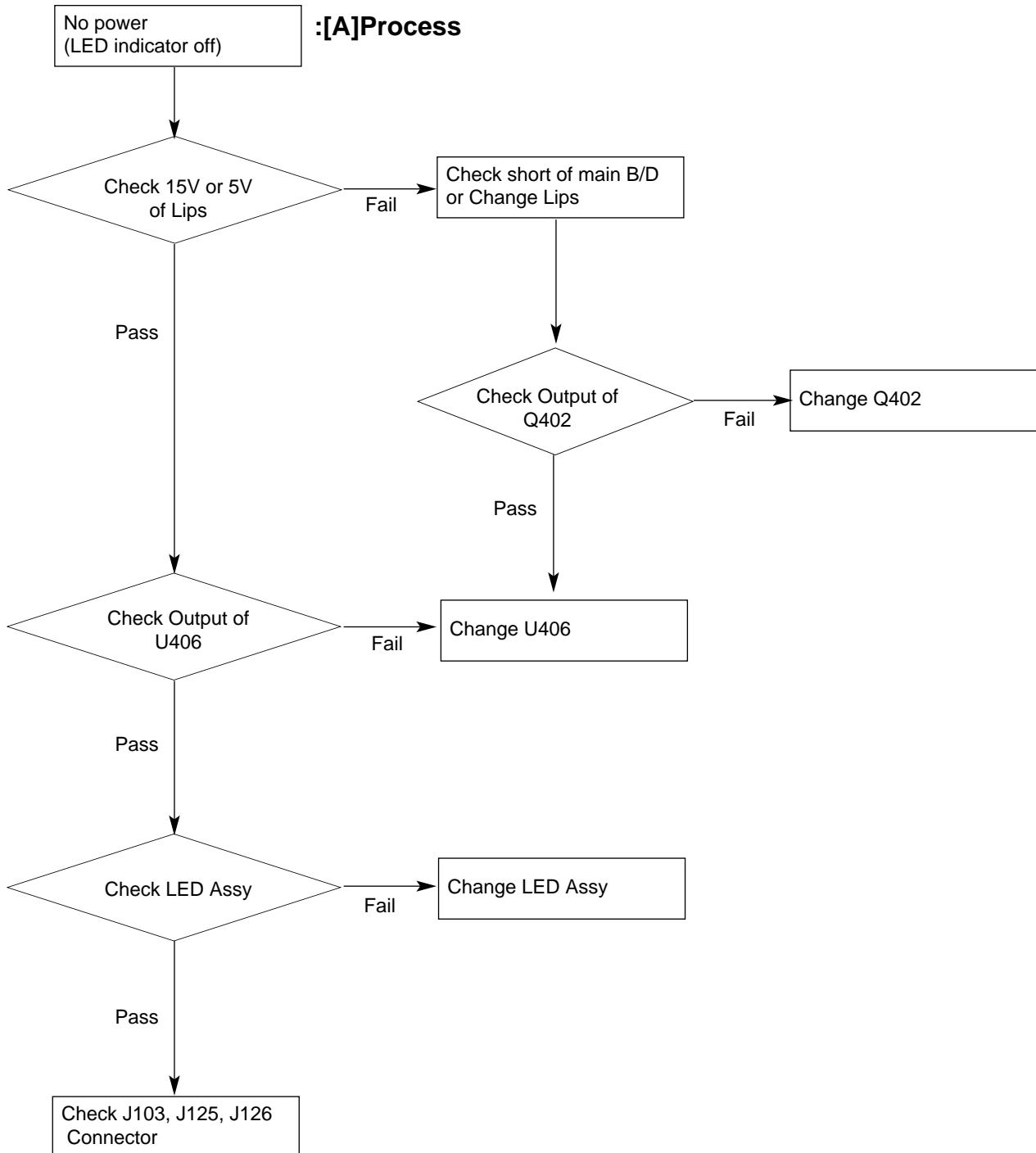
1. Push "IN-Start" key in SVC remote controller.
2. Push "Menu" key in remote controller over 5 seconds the while pushing "Menu" key of Local button.  
(If SVC OSD appear, remove the finger on "Menu" key in remote controller first of all)

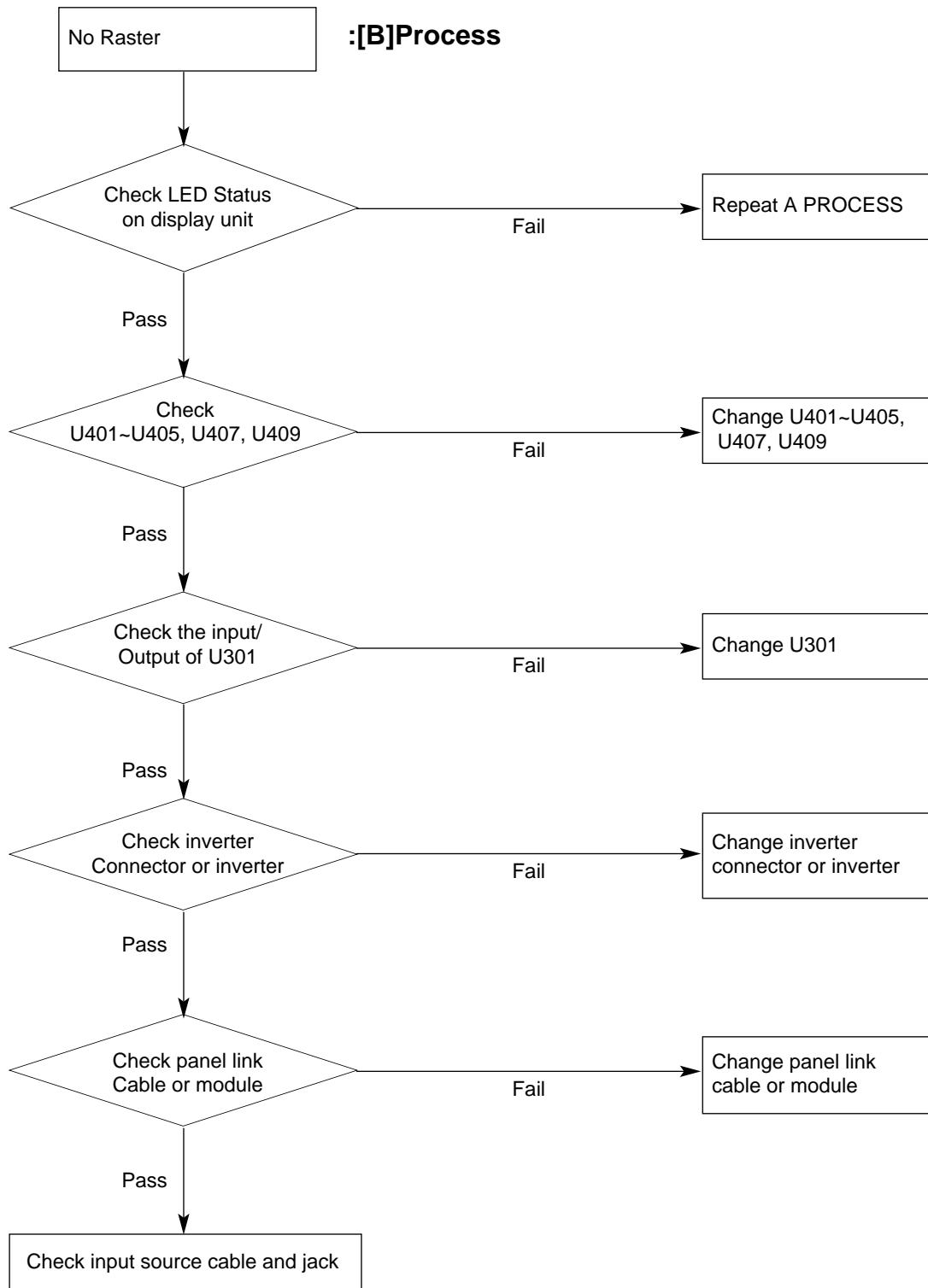
# SVC REMOCON

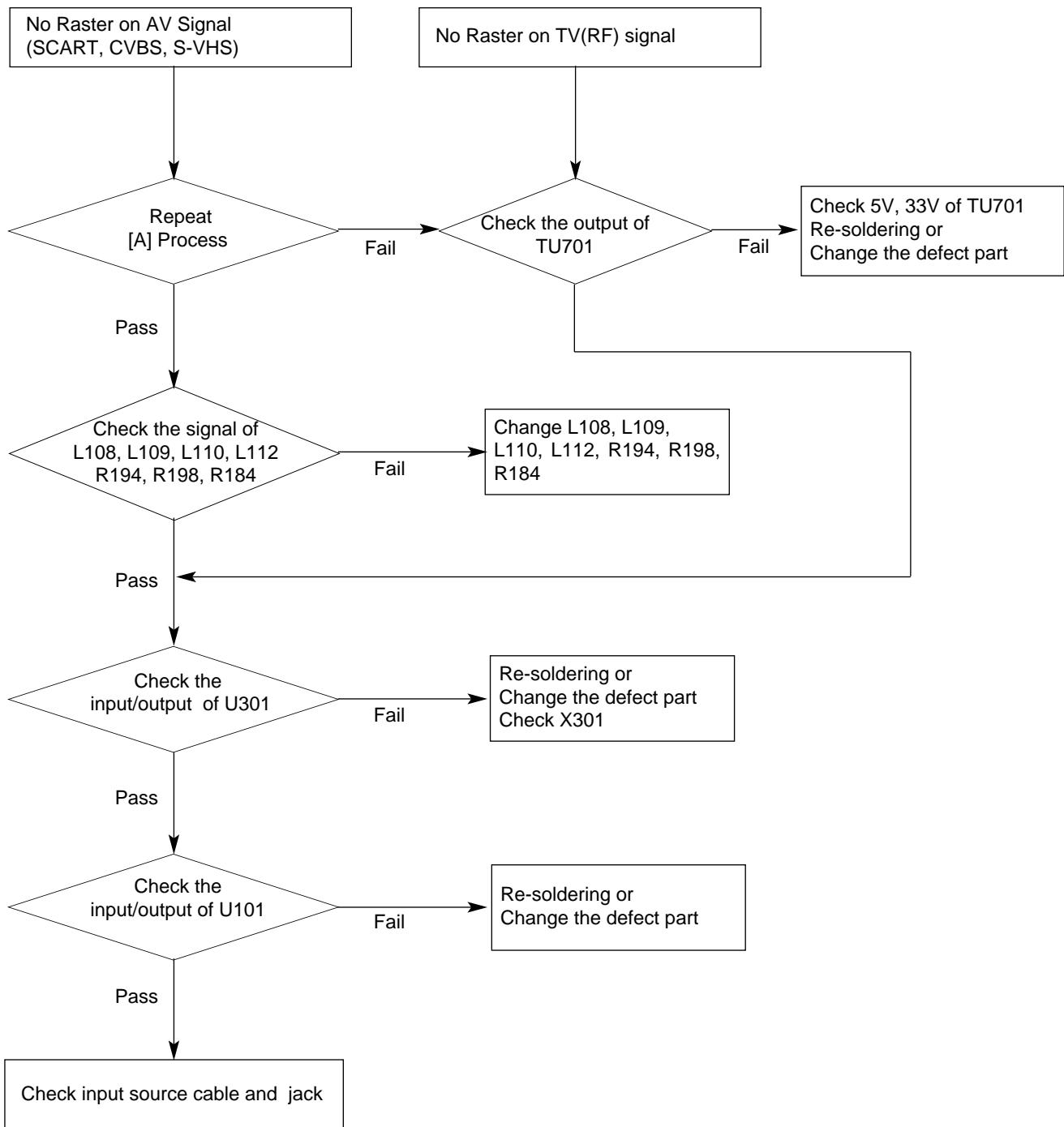
NO.	KEY	FUNTION	REMARK
1	POWER	To turn the TV on or off	
2	MUTE	To activate the mute function.	
3	P-CHECK	To check TV screen image easily.	Shortcut keys
4	S-CHECK	To check TV screen sound easily	Shortcut keys
5	ARC(23inch)	To select size of the main screen (Auto, 4:3, 16:9, 14:3, Zoom, Cinema Zoom)	Shortcut keys
6	CAPTION	Switch to closed caption broadcasting	
7	TXT	To toggle on/off the teletext mode	
8	TV/AV	External input	
9	IN-START	To enter adjustment mode when manufacturing the TV sets. In-Start→Vol±→Auto ADC→Vol±→W/B adjustment→ Exit two times(Adjustment completed)	Use the AV key to enter the screen W/B adjustment mode.
10	MPX	To select the multiple sound mode (Mono, Stereo or MPEG, DOLBY, Digital)	
11	EXIT	To release the adjustment mode	
12	APC(PSM)	To easily adjust the screen according to surrounding brightness	
13	ASC(SSM)	To easily adjust sound according to the program type	
14	MULTIMEDIA	External input	Shortcut keys
15	CH ±	To move channel up/down or to select a function displayed on the screen.	
16	VOL ±	To adjust the volume or accurately control a specific function.	
17	ENTER	To set a specific function or complete setting.	
18	CH-(OP1)	To use as a <b>red key</b> in the teletext mode	
19	CH+(OP2)	To use as a <b>green key</b> in the teletext mode	
20	SWAP(OP3)	To use as a <b>yellow key</b> in the teletext mode	
21	INPUT(OP4)	To use as a <b>blue key</b> in the teletext mode	
22	MENU	To select the functions such as video, voice, function or channel.	
23	IN-STOP	To set the delivery condition status after manufacturing the TV set.	
24	HOLD	Used as a hold key in the teletext mode (Page updating is stopped.)	
25	TIME	Displays the teletext time in the normal mode Enables to select the sub code in the teletext mode	
26	SIZE	Used as the size key in the teletext mode	
27	INDEX	Used as the index key in the teletext mode (Top index will be displayed if it is the top text.)	
28	UPDATE	Used as the update key in the teletext mode (Text will be displayed if the current page is updated.)	
29	MODE	Used as Mode in the teletext mode	
30	TIILT	To set IIC SW "0" or "1" in the adjustment mode	
31	0~9	To manually select the channel.	

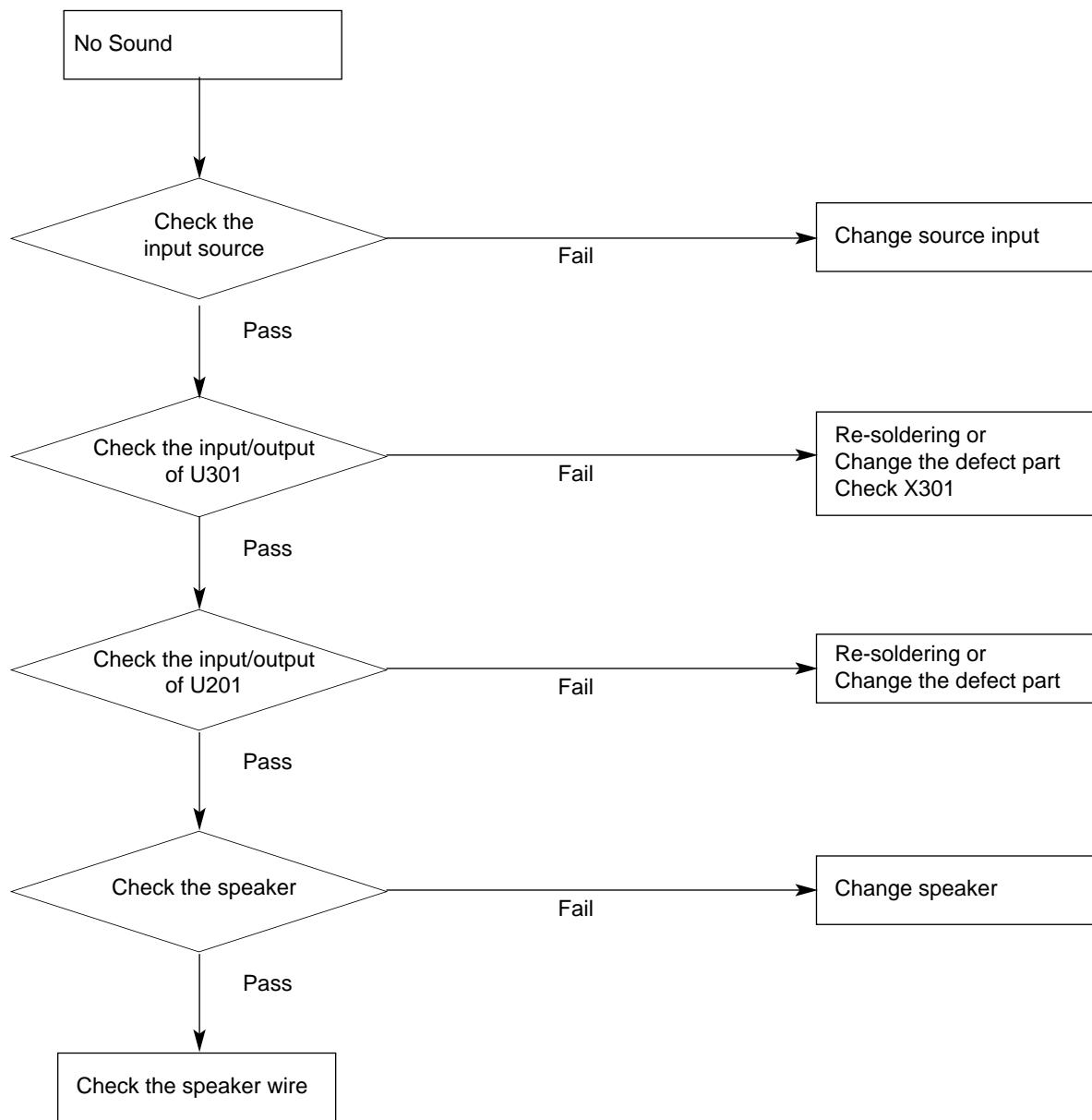


# TROUBLESHOOTING

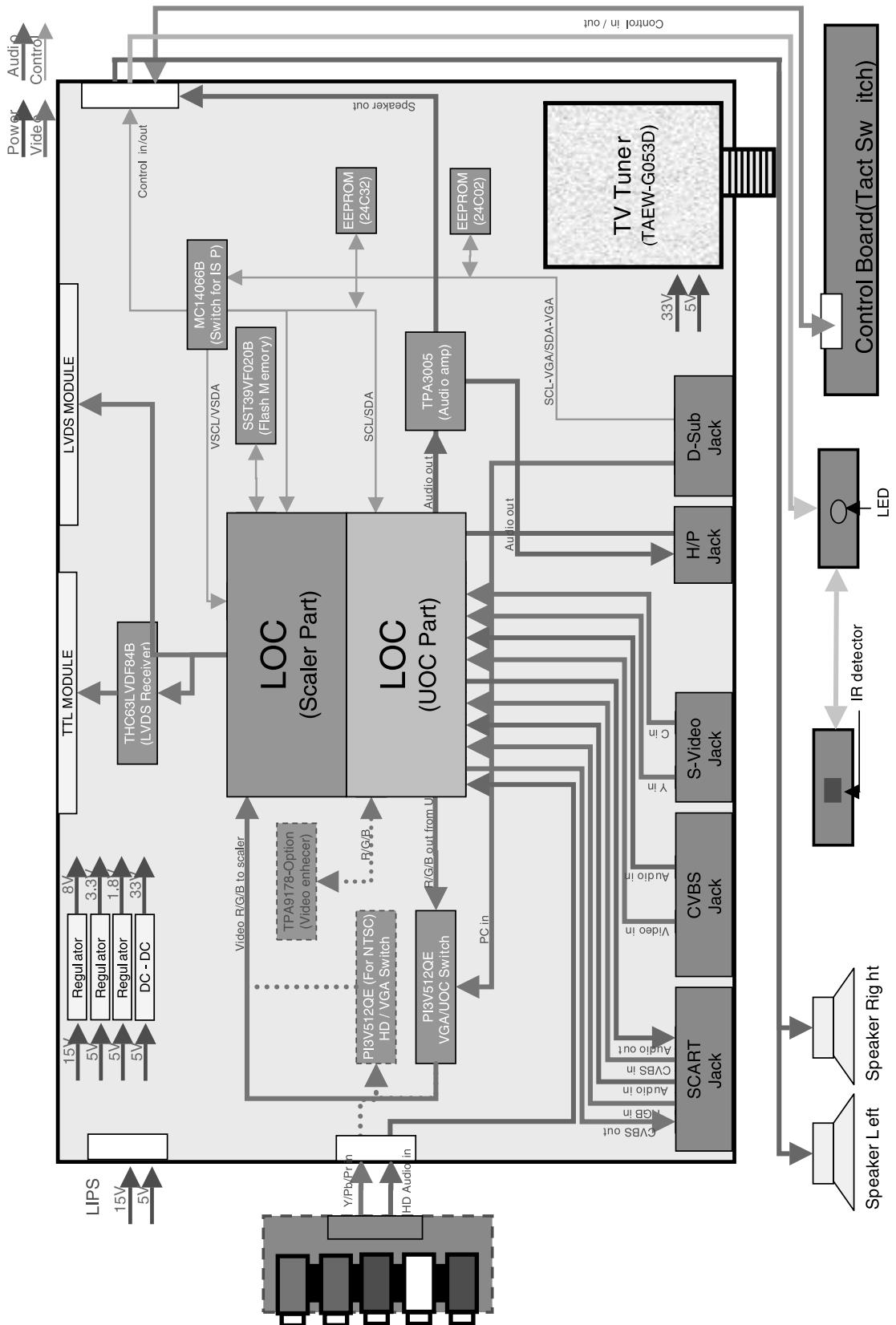








# BLOCK DIAGRAM



# BLOCK DIAGRAM DESCRIPTION

## **Power Supply Block (LIPS)**

This Block Generates DC Voltage (5V,15V) to Main Control system from AC Power (100-240 V, 50/60 Hz, 1.0A)

Also it has the inverter function that converts input voltage to AC Rms value for the LCD lamp.

## **DC/DC Converter block**

DC/DC Converter convert the input 5V,15V to proper 3.3V, 5V, 8V, 12V for Main control system.

For shooting heat trouble, we use the DC/DC converting IC

## **Audio Amplifier**

This block is composed of TPA3005D2 and peripheral device.

The function of the audio amplifier is that to amplify audio L / R signal transmitted from audio decoder. The audio signal is amplified according to pre-defined DC volume control curve.

## **Audio / Video / IF Decoder / Scaler**

This block is composed of LOC1 and peripheral devices.

### 1) Video Decoder

This Block Selects input Video signals (like CVBS, Y/C, SCART RGB) and output RGB signal.

On decoding, We can control signal like Contrast, Brightness, Sharpness, Color, tint signals including Adaptive Comb Filter

### 2) Audio Decoder

This block analyzes audio input signal through A/V Jack and PC audio and Tuner IF.

The analyzed signals transmitted to audio amplifier

On decoding, We can control signal like Bass, treble.

### 3) IF Decoder

This block can change IF signal to audio and video signal that transmitted to Video/audio decoder.

### 4) Scaler

This IC includes A/D Converter and LVDS Transmitter

This IC is directly Inputted Analog Signal and transmits it to LCD Module

### 5) Micom

This block controls each IC through IIC communication line.

## **LVDS Rx (DTC34LF86L)**

It is composed of DTC34LF86L/THC63LVDF84B.

The LVDS Rx converts the LVDS data streams back into 24bits of CMOS/TTL data with Falling edge or rising edge clock for convenient with variety of LCD panel controllers.

## **Switch IC (PI3V512QE)**

It is composed of PI3V512QE.

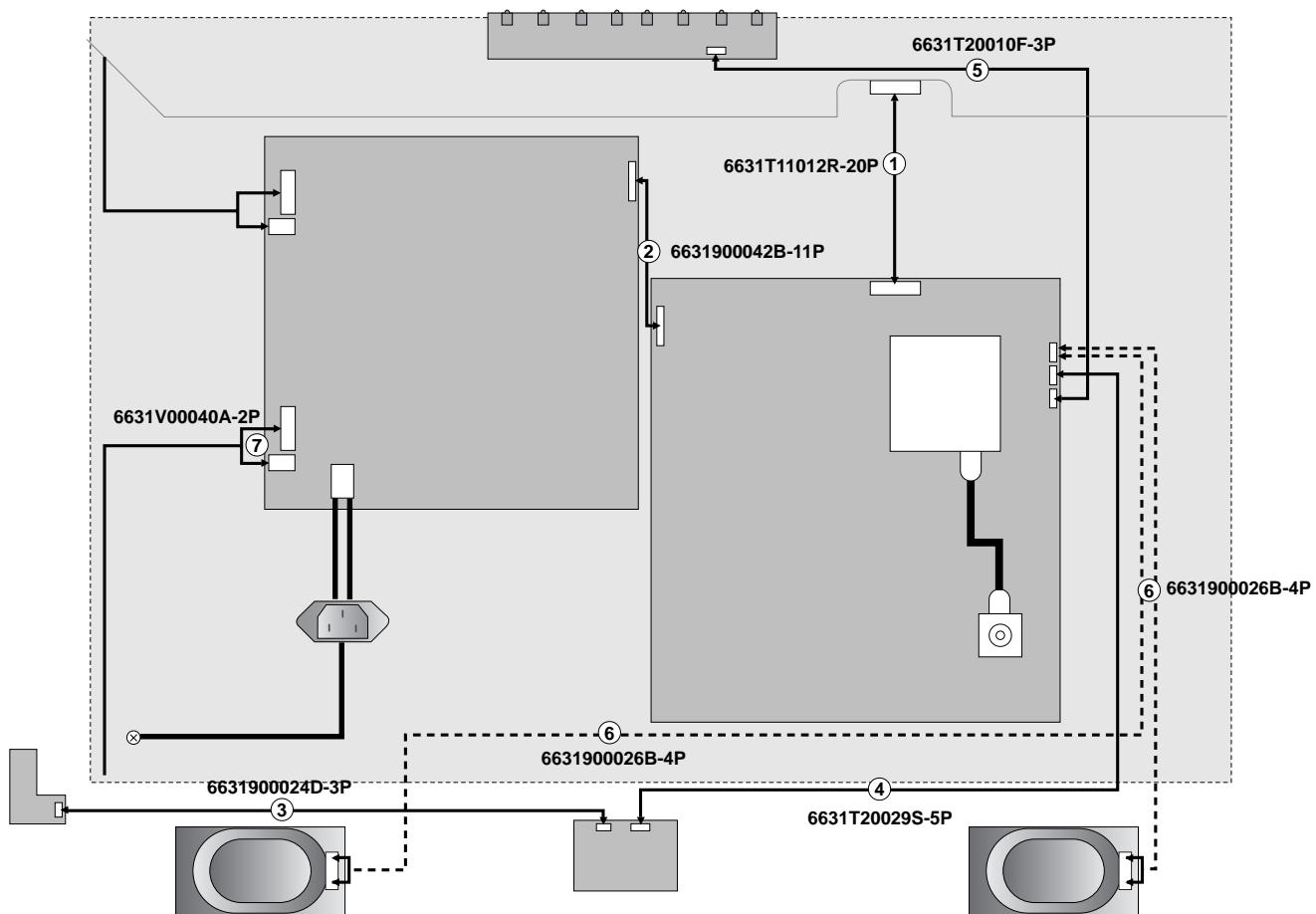
This IC selects between D-sub RGB signal and LOC1 RGB signal, and it transmits the selected signal to video signal processor.

## **TUNER**

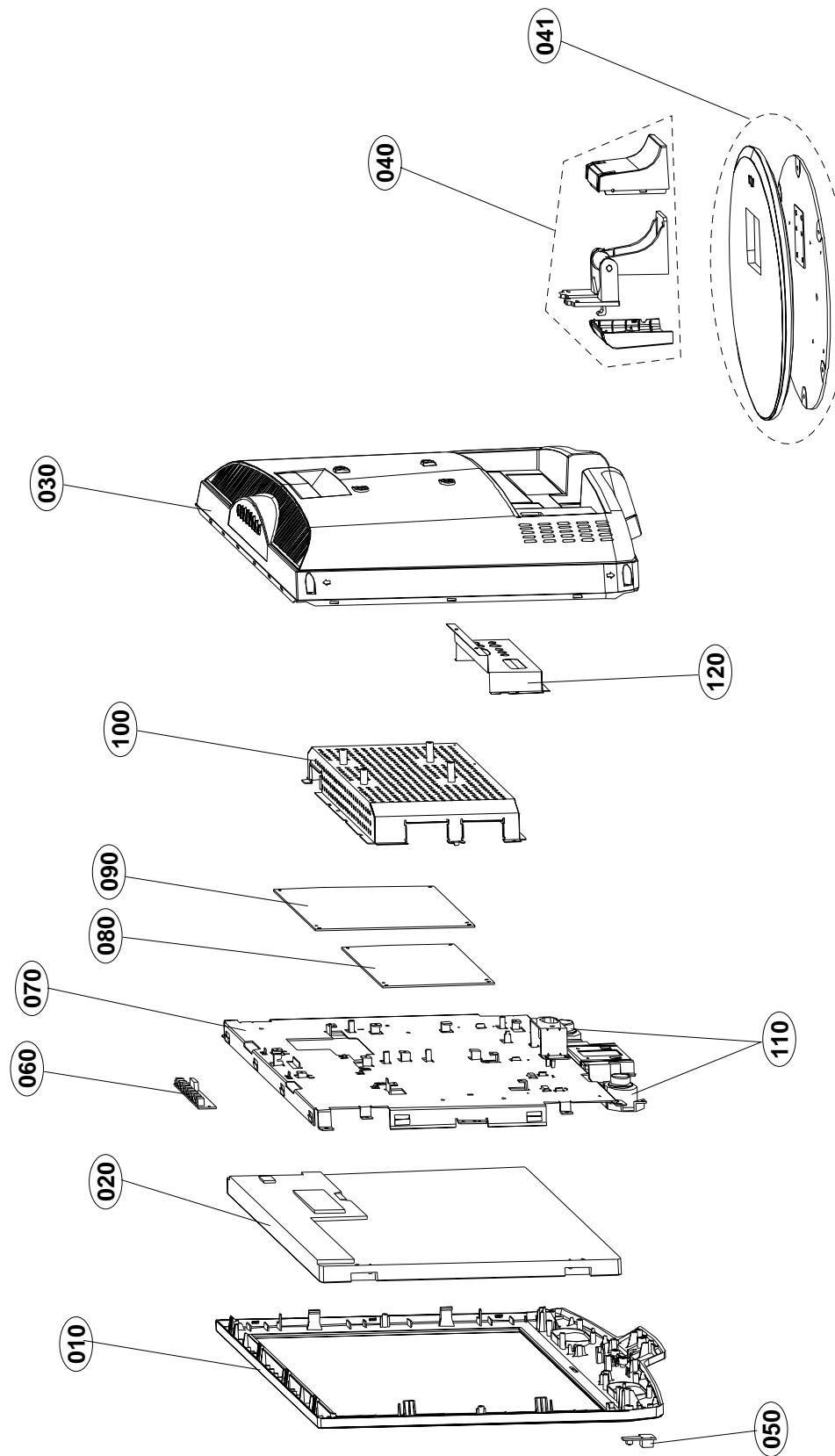
Micom controls this through IIC Line.

TUNER makes IF and transmits IF signal to LOC1.

# WIRING DIAGRAM



## EXPLODED VIEW



## EXPLODED VIEW PARTS LIST

No.	PART NO.	DESCRIPTION
010	30919B0002E	CABINET ASSEMBLY, 15LC1 BRAND . TITAN SILVER C/SKD
020	6304FLP234A	LCD(LIQUID CRYSTAL DISPLAY), LC150X02-TL01 LG PHILPS TFT COLOR TN LAMP MULTI
030	3809900013H	BACK COVER ASSEMBLY, 15LC1 2PHONE FOR RZ C/SKD
040	3043900039A	TILT SWIVEL ASSEMBLY, 15LC1 . STAND BODY ASSY
041	3043900040A	TILT SWIVEL ASSEMBLY, 15LC1 . STAND BASE ASSY
050	68719ST957A	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 15LC1R SNRULFT LED IR
060	68719ST956A	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 15LC1R SNRULFT CONTROL
070	49519S0004F	METAL ASSEMBLY, FRAME MAIN ASSY-15LC1-LPL TN C/SKD
080	6871TPT318A	PWB(PCB) ASSEMBLY,POWER, MFT 4-LAMP POWER TOTAL BRAND .
090	33139P1006A	MAIN TOTAL ASSEMBLY, 15LC1R-ZG.SNRULFT BRAND CL-81
100	49519K0117A	METAL ASSEMBLY, SHIELD AV 15LC1
110	6400GTTX02A	SPEAKER,FULLRANGE, EF1527C-6428-6 TOPTONE FULL-RANGE(GENERAL) 160HM 5/7W 82DB OTHERS 40*70 210HZ
120	49519K0116B	METAL ASSEMBLY, REAR 15LC1 C/SKD

## REPLACEMENT PARTS LIST

For Capacitor & Resistors, the characters at 2nd and 3rd digit in the P/No. means as follows;	CC, CX, CK, CN, CH : Ceramic	RD : Carbon Film
	CQ : Polyester	RS : Metal Oxide Film
	CE : Electrolytic	RN : Metal Film
	CF : Fixed Film	RH : CHIP, Metal Glazed(Chip)
		RR : Drawing

DATE: 2005. 11. 13.				
*S	*AL	LOC. NO.	PART NO.	DESCRIPTION / SPECIFICATION
<b>MAIN BOARD</b>				
<b>CAPACITOR</b>				
			C3061	0.1UF 50V 10% X7R 2012 R/TP
			C3064	"0.47UF 25V 80%,-20% F(Y5V)"
			C3082	"2.2UF 2012 25V 80%,-20% F(Y"
			C3083	"2.2UF 2012 25V 80%,-20% F(Y"
			C3084	0.1UF 50V 10% X7R 2012 R/TP
			C3093	0.1UF 50V 10% X7R 2012 R/TP
			C3102	4.7UF 2012 10V 10% X5R R/TP
			C313	0.1UF 50V 10% X7R 2012 R/TP
			C331	10000PF 50V 10% B(Y5P) 2012
			C332	0.1UF 50V 10% X7R 2012 R/TP
			C334	0.1UF 50V 10% X7R 2012 R/TP
			C335	0.1UF 50V 10% X7R 2012 R/TP
			C336	0.1UF 50V 10% X7R 2012 R/TP
			C337	0.1UF 50V 10% X7R 2012 R/TP
			C338	0.1UF 50V 10% X7R 2012 R/TP
			C339	0.1UF 50V 10% X7R 2012 R/TP
			C340	0.1UF 50V 10% X7R 2012 R/TP
			C341	0.1UF 50V 10% X7R 2012 R/TP
			C342	0.1UF 50V 10% X7R 2012 R/TP
			C343	0.1UF 50V 10% X7R 2012 R/TP
			C347	0.1UF 50V 10% X7R 2012 R/TP
			C348	0.1UF 50V 10% X7R 2012 R/TP
			C350	0.1UF 50V 10% X7R 2012 R/TP
			C358	0.1UF 50V 10% X7R 2012 R/TP
			C360	0.1UF 50V 10% X7R 2012 R/TP
			C361	0.1UF 50V 10% X7R 2012 R/TP
			C362	0.1UF 50V 10% X7R 2012 R/TP
			C363	0.1UF 50V 10% X7R 2012 R/TP
			C364	0.1UF 50V 10% X7R 2012 R/TP
			C365	0.1UF 50V 10% X7R 2012 R/TP
			C366	0.1UF 50V 10% X7R 2012 R/TP
			C373	0.1UF 50V 10% X7R 2012 R/TP
			C374	0.1UF 50V 10% X7R 2012 R/TP
			C375	0.1UF 50V 10% X7R 2012 R/TP
			C379	1000PF 50V 5% NPO 2012 R/TP
			C386	0.1UF 50V 10% X7R 2012 R/TP
			C388	0.1UF 50V 10% X7R 2012 R/TP
			C389	0.1UF 50V 10% X7R 2012 R/TP
			C390	0.1UF 50V 10% X7R 2012 R/TP
			C391	0.1UF 50V 10% X7R 2012 R/TP
			C396	0.1UF 50V 10% X7R 2012 R/TP
			C403	0.1UF 50V 10% X7R 2012 R/TP
			C409	0.1UF 50V 10% X7R 2012 R/TP
			C411	4.7UF 2012 10V 10% X5R R/TP
			C413	10000PF 50V 10% B(Y5P) 2012
			C415	1UF 2012 25V 10% X7R R/TP
			C416	0.1UF 50V 10% X7R 2012 R/TP
			C421	0.1UF 50V 10% X7R 2012 R/TP
			C422	0.1UF 50V 10% X7R 2012 R/TP
			C425	"1UF 2012 25V 80%,-20% F(Y5V)"
			C704	0.1UF 50V 10% X7R 2012 R/TP
			C705	0.1UF 50V 10% X7R 2012 R/TP
			C708	0.1UF 50V 10% X7R 2012 R/TP
			C740	10000PF 50V 10% B(Y5P) 2012





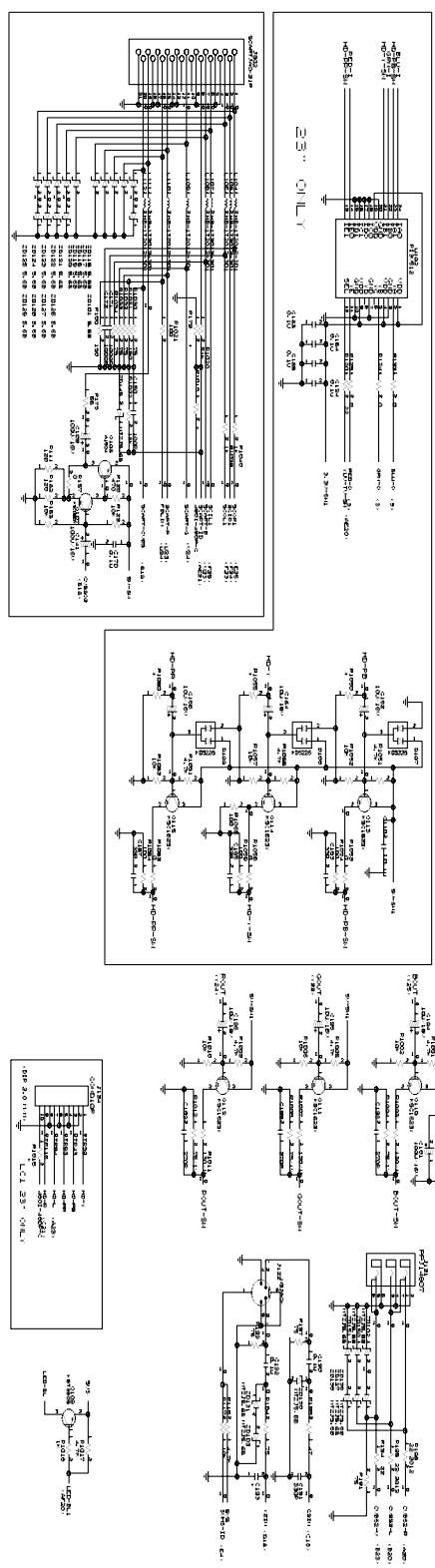
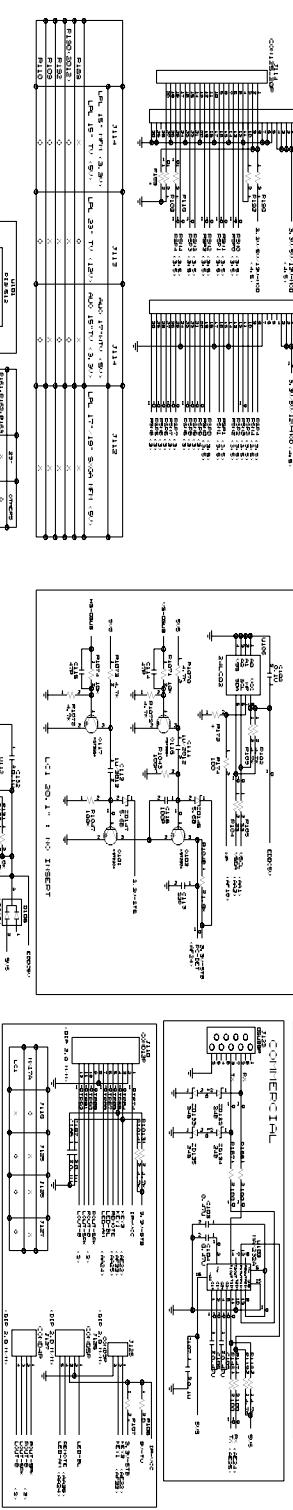
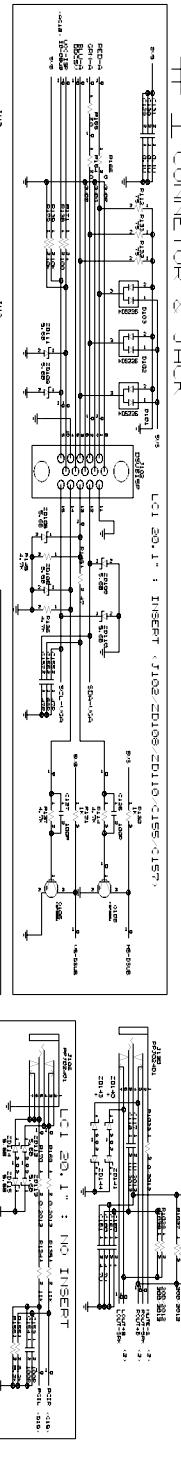
DATE: 2005. 11. 13.				
*S	*AL	LOC. NO.	PART NO.	DESCRIPTION / SPECIFICATION
		L302	6200J00005E	HH-1M2012-601JT CERATEC R/T
		L305	6200J00005E	HH-1M2012-601JT CERATEC R/T
		L307	6200J00005E	HH-1M2012-601JT CERATEC R/T
		L308	6200J00005E	HH-1M2012-601JT CERATEC R/T
		L324	6200J00005E	HH-1M2012-601JT CERATEC R/T
		L330	6200J00005E	HH-1M2012-601JT CERATEC R/T
		L333	6200J00005E	HH-1M2012-601JT CERATEC R/T
		U701	6200QL3003A	K3965D EPCOS BULK PAL VIDEO
		U702	6200QL3003B	K9656D EPCOS BULK PAL SOUND
		L704	OLC0562001A	0.56UH 10% 2012 R/TC FI-A20
		L731	OLC1020101A	1UH 10% 2012 R/TC FI-B2012-
<b>TRANSISTOR</b>				
		Q203	OTR162309CA	KSC1623 TP SAMSUNG SOT23 N
		Q107	OTR162309CA	KSC1623 TP SAMSUNG SOT23 N
		Q110	OTR162309CA	KSC1623 TP SAMSUNG SOT23 N
		Q111	OTR162309CA	KSC1623 TP SAMSUNG SOT23 N
		Q112	OTR162309CA	KSC1623 TP SAMSUNG SOT23 N
		Q704	OTR162309CA	KSC1623 TP SAMSUNG SOT23 N
		Q101	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q102	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q103	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q109	OTR390609FA	FAIRCHILD KST3906-MTF TP SO
		Q116	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q117	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q701	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q715	OTR387500AA	CHIP 2SC3875S(ALY) BK KEC -
		Q301	OTR127009AA	KTA1270-Y(KTA562TM) TP KEC
		Q302	OTR127009AA	KTA1270-Y(KTA562TM) TP KEC
		Q105	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q106	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q108	OTR150400BA	CHIP 2SA1504S(ASY) BK KEC -
		Q201	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q304	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q305	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q402	OTR390409AE	FAIRCHILD KST3904(LGEMTF) T
		Q702	OTR388109AA	KTC3881 CHIP TP KEC --
		U405	OTFV180067A	SI3865BDV(E3) VISHAY R/TP T
		U406	OTF492509AA	SI4925DY TP TEMIC 30V 6.1A
<b>RESISTORs</b>				
		R334	0RH1004D422	1M OHM 1 / 10 W 1% D R/TP
		R335	0RH3902D422	39K OHM 1 / 10 W 1% D R/TP
		R751	0RH3902D422	39K OHM 1 / 10 W 1% D R/TP
		R776	0RX0202K665	20 OHM 2 W 5% SF15
		R1001	0RH4701D622	4.7K OHM 1 / 10 W 2012 5.00
		R1002	0RH1002D622	10K OHM 1 / 10 W 2012 5.00%
		R1005	0RH4701D622	4.7K OHM 1 / 10 W 2012 5.00
		R1006	0RH1002D622	10K OHM 1 / 10 W 2012 5.00%
		R1009	0RH4701D622	4.7K OHM 1 / 10 W 2012 5.00
		R1010	0RH1002D622	10K OHM 1 / 10 W 2012 5.00%
		R1013	0RH4701D622	4.7K OHM 1 / 10 W 2012 5.00
		R1014	0RH4701D622	4.7K OHM 1 / 10 W 2012 5.00
		R1017	0RH4701D622	4.7K OHM 1 / 10 W 2012 5.00
		R1018	0RH1001D622	1K OHM 1 / 10 W 2012 5.00%
		R1020	0RH5102D622	51K OHM 1 / 10 W 2012 5.00%
		R1021	0RH1000D622	100 OHM 1 / 10 W 2012 5.00%
		R1022	0RH1802D622	18K OHM 1 / 10 W 2012 5.00%
		R1026	0RH3900D622	390 OHM 1 / 10 W 2012 5.00%
		R1027	0RH3900D622	390 OHM 1 / 10 W 2012 5.00%



DATE: 2005. 11. 13.				
*S	*AL	LOC. NO.	PART NO.	DESCRIPTION / SPECIFICATION
		R301	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R3010	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R3015	ORJ1502D677	15K OHM 1/10 W 5% 1608 R/TP
		R3016	ORJ1502D677	15K OHM 1/10 W 5% 1608 R/TP
		R302	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R3020	ORJ0222D677	22 OHM 1/10 W 5% 1608 R/TP
		R3021	ORJ0222D677	22 OHM 1/10 W 5% 1608 R/TP
		R303	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R312	ORJ0000D677	0 OHM 1/10 W 5% 1608 R/TP
		R313	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R316	ORJ1001D677	1K OHM 1/10 W 5% 1608 R/TP
		R317	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R318	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R319	ORJ2002D677	20000 OHM 1/10 W 5% 1608 R/
		R320	ORJ0332D677	33 OHM 1/10 W 5% 1608 R/TP
		R326	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R332	ORJ0682D677	68 OHM 1/10 W 5% 1608 R/TP
		R336	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R342	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R343	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R344	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R351	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R355	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R356	ORJ1000D677	100 OHM 1/10 W 5% 1608 R/TP
		R370	ORJ1002D677	10K OHM 1/10 W 5% 1608 R/TP
		R372	ORJ1002D677	10K OHM 1/10 W 5% 1608 R/TP
		R373	ORJ4701D677	4.7K OHM 1/10 W 5% 1608 R/T
		R375	ORJ0332D677	33 OHM 1/10 W 5% 1608 R/TP
		R376	ORJ3900D677	390 OHM 1/10 W 5% 1608 R/TP
		R377	ORJ0332D677	33 OHM 1/10 W 5% 1608 R/TP
		R378	ORJ1202D677	12K OHM 1/10 W 5% 1608 R/TP
		R379	ORJ4701D677	4.7K OHM 1/10 W 5% 1608 R/T
		R380	ORJ0332D677	33 OHM 1/10 W 5% 1608 R/TP
		R384	ORJ0332D677	33 OHM 1/10 W 5% 1608 R/TP
		R387	ORJ0332D677	33 OHM 1/10 W 5% 1608 R/TP
		R399	ORJ0332D677	33 OHM 1/10 W 5% 1608 R/TP
		R410	ORJ2202D677	22K OHM 1/10 W 5% 1608 R/TP
		R411	ORJ5600D677	560 OHM 1/10 W 5% 1608 R/TP
		R417	ORJ0000D677	0 OHM 1/10 W 5% 1608 R/TP
		R418	ORJ0000D677	0 OHM 1/10 W 5% 1608 R/TP
		R533	ORJ4701D677	4.7K OHM 1/10 W 5% 1608 R/T
		R534	ORJ4701D677	4.7K OHM 1/10 W 5% 1608 R/T
		R714	ORJ1002D677	10K OHM 1/10 W 5% 1608 R/TP
		R720	ORJ1201D677	1200 OHM 1/10 W 5% 1608 R/T
		R729	ORJ4702D677	47000 OHM 1/10 W 5% 1608 R/
		R770	ORJ0562D677	56 OHM 1/10 W 5% 1608 R/TP
		R771	ORJ1501D677	1.5K OHM 1/10 W 5% 1608 R/T
		R773	ORJ3000D677	300 OHM 1/10 W 5% 1608 R/TP
		R774	ORJ0682D677	68 OHM 1/10 W 5% 1608 R/TP
OTHERs				
		X301	6202TST003G	HC-49/SM5H KONY 24.576MHZ +
		U303	6620F00017A	CCSD-32T-SM WOODYOUNG 32P PL
		TU701	6700VS0003H	TAEW-G053P LGIT MULTI FS PH
LED&IR BOARD				
		ZD504	ODZ560009CF	MTZJ5.6B TP ROHM-K DO34 0.5
		U501	6712SCA232A	TSOP34838S01 VISHAY 38KHZ L
		LED551	ODLBE0048AA	BRIGHT LED ELECTRONICS BL-H
		LED552	ODLBE0048AA	BRIGHT LED ELECTRONICS BL-H

BLUE BIRD II-1X17A, LCI 15" / 17" / 20.1" / 23"

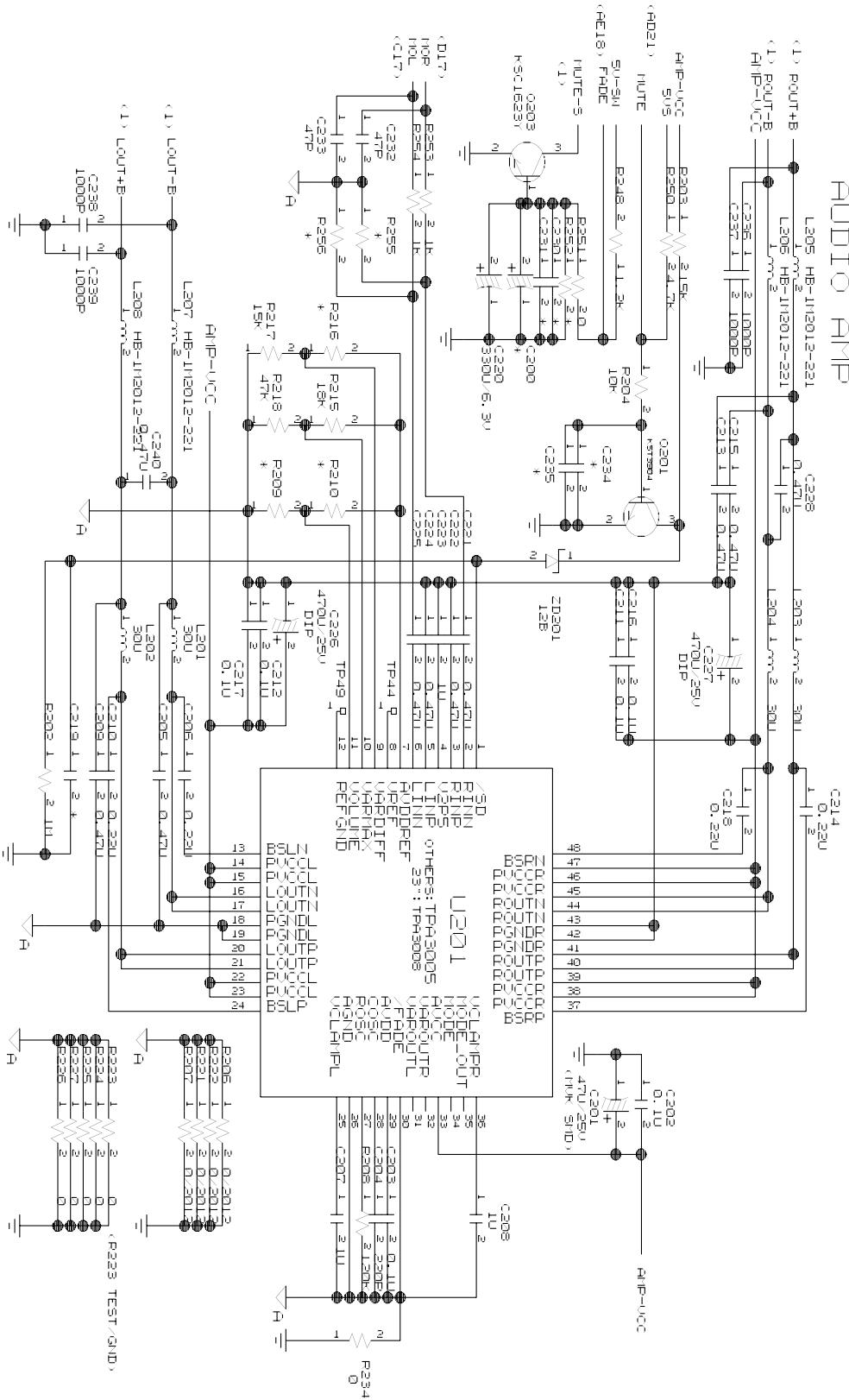
# 1 PAL/SECAM CONNECTOR & JACK



BLUE BIRD II-MIX 17A, LC1 15" X 17" X 20. 1" X 23"

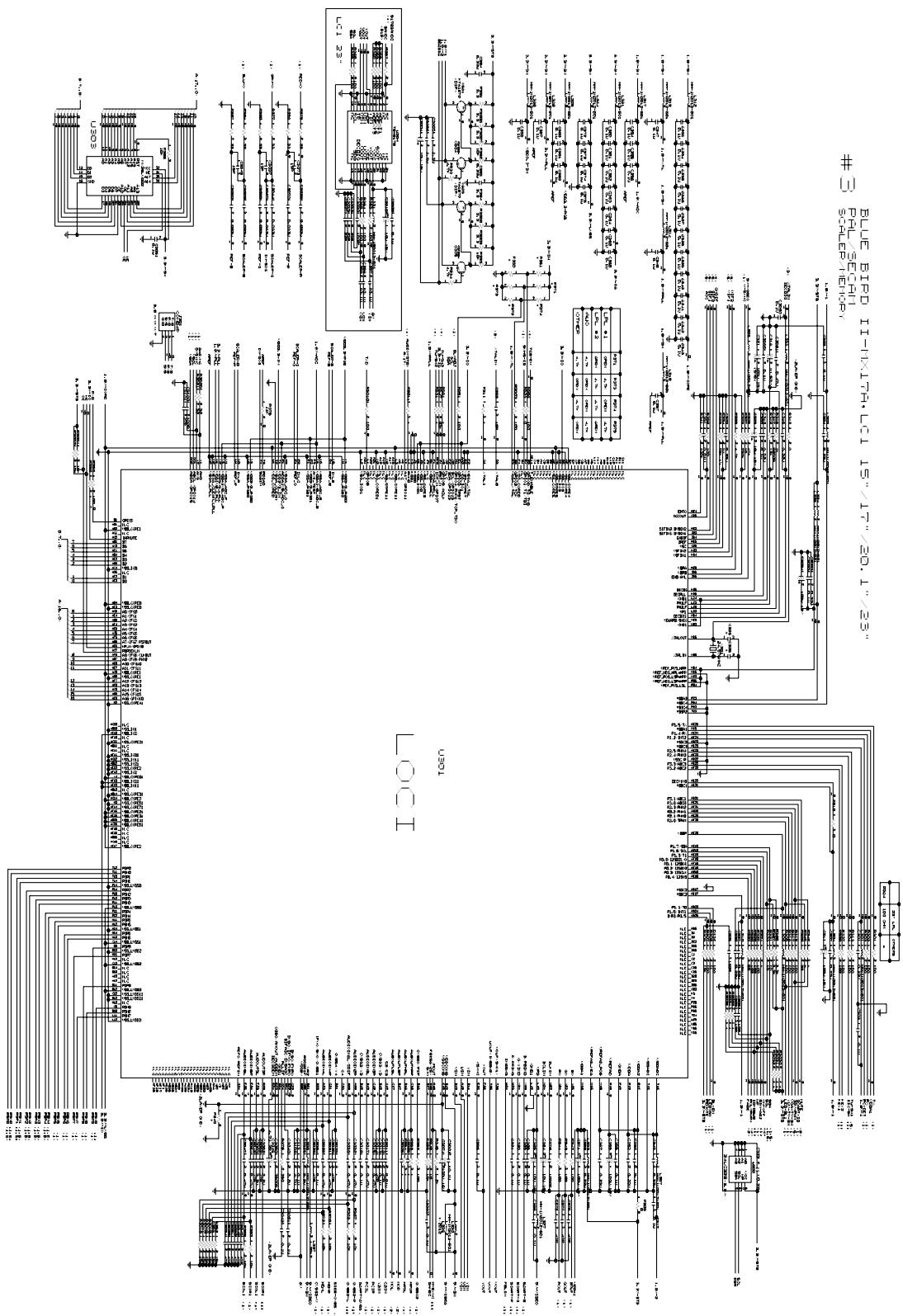
## #2 PAL/SECAM

### AUDIO AMP



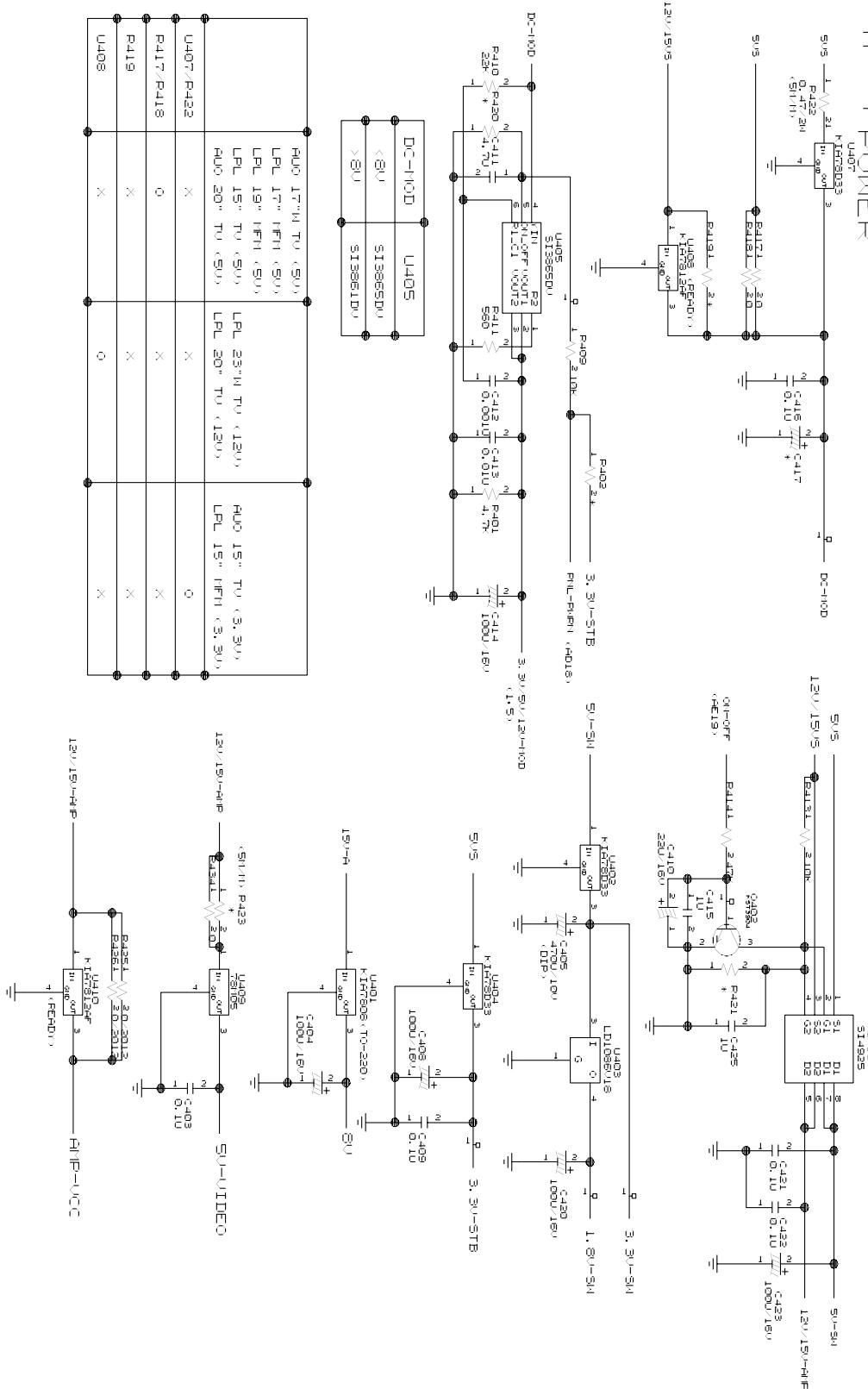
# 3 BLUE BIRD III-1X17H, LCI 15" / 17" / 20, 1" / 23"

PRU/SECAL  
SCALE/HORN



# BLUE BIRD II-MIX17A LC1 15" / 17" / 20" 1" / 23"

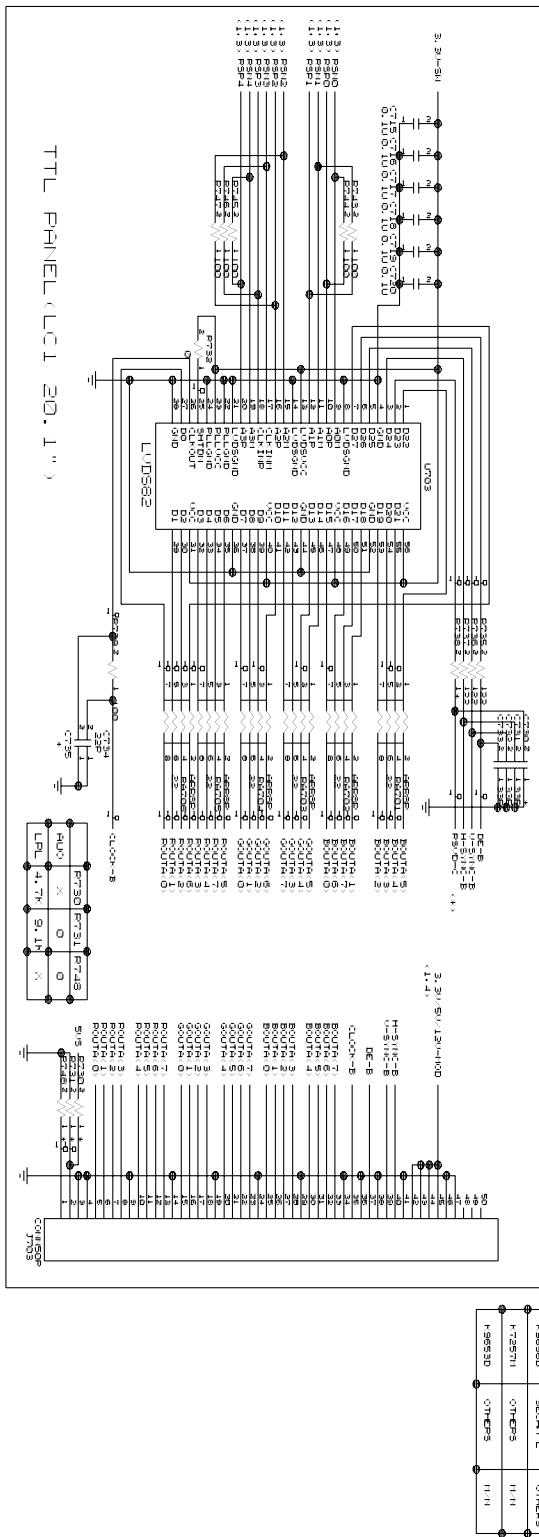
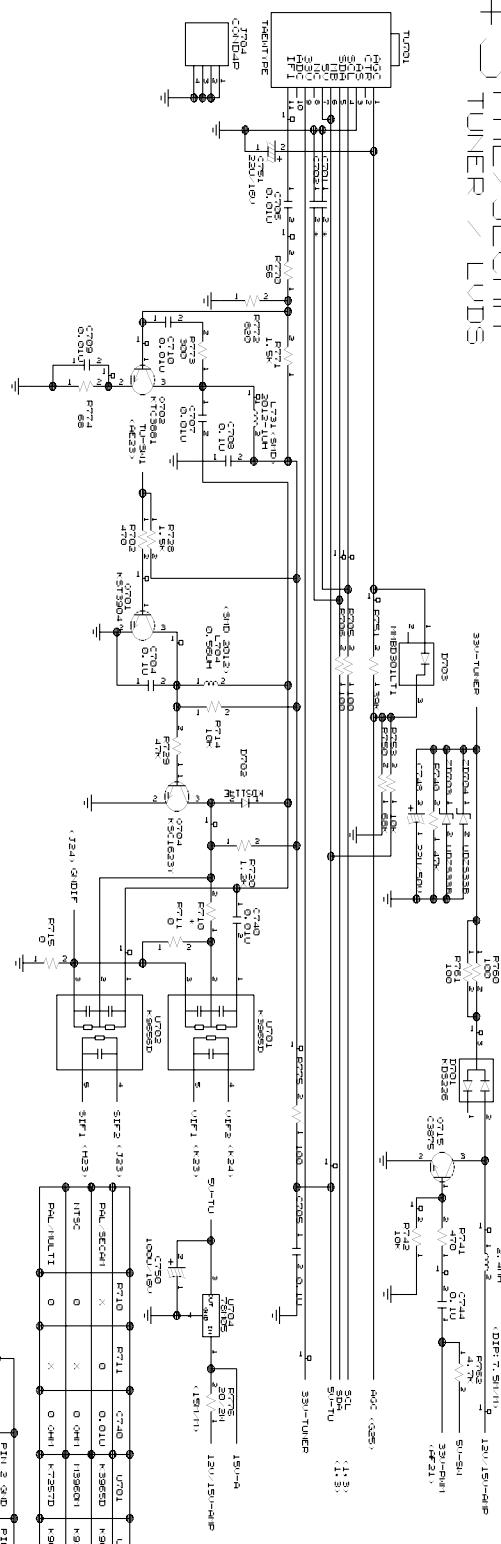
## #4 PAL / SECAM POWER



BLUE BIRD II-MIX 17A, LC1 15" / 17" / 20" 1" / 23"

#5 SPAL/SECAM

TUNER / LUD





**LG Electronics Inc.**

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